

REV.	DESCRIPTION	DATE
A/0	新版发行	2016.11.28

技术要求:

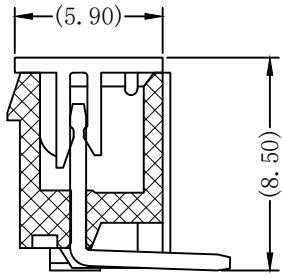
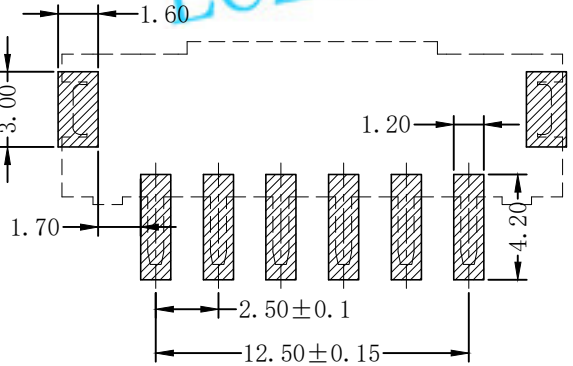
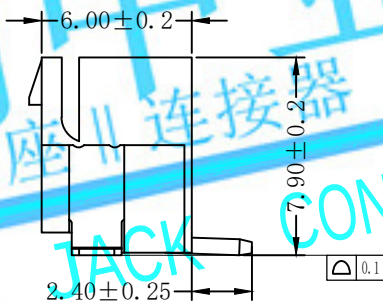
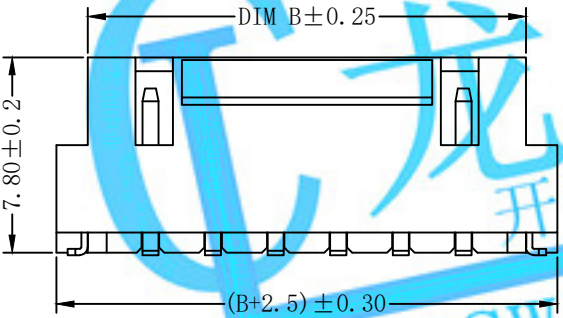
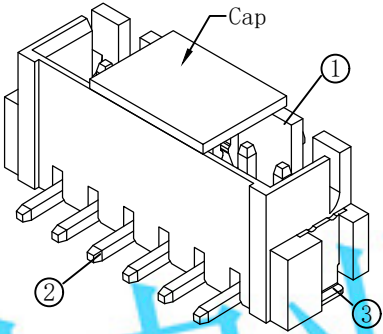
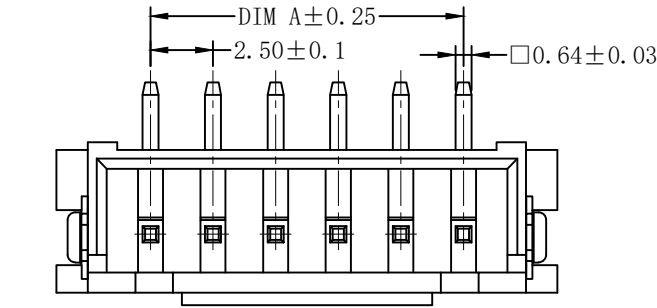
- 1、塑件材料: LCP (UL-94V-0)
- 2、接触件: 黄铜镀锡
- 3、接触电阻: $\leq 20\text{m}\Omega$
- 4、绝缘电阻: $\geq 1000\text{M}\Omega$
- 5、额定电压: 250V AC DC
- 6、额定电流: 3.0A AC DC
- 7、耐压: 能承受1000V AC/Minute
- 8、工作温度: $-25^{\circ}\sim +105^{\circ}$
- 9、可焊性试验: 浸锡面积 $\geq 95\%$ 温度 260^{+5}_{-0} , 时间 2.5 ± 0.5 秒
- 10、铅和镉等六大有害物质含量要符合环保要求

XHB-2.54-XP-LT-DK

Circuits	Dimensions (mm)	
	A	B
02	2.50	7.50
03	5.00	10.00
04	7.50	12.50
05	10.00	15.00
06	12.50	17.50
07	15.00	20.00
08	17.50	22.50
09	20.00	25.00
10	22.50	27.50
11	25.00	30.00
12	27.50	32.50
13	30.00	35.00
...	...	...
20	47.50	52.50

3	焊片 Fitting Nail	黄铜 Brass	2	电镀(锡): 整个表面镀底镍30u"MIN, 再镀锡80u"MIN.
2	端子 Contact	黄铜 Brass	n*1	电镀(锡): 整个表面镀底镍30u"MIN, 再镀锡80u"MIN.
1	基座 Wafer	LCP (UL94V-0)	1	本色
序号	名称	材料	数量	附注

GENERAL TOLERANCES			DRAWN BY	龙创中业电子科技(东莞)有限公司		
0.X ±0.25	X° ±3°	CHK. BY				
0.XX ±0.12		APRV. BY				
0.XXX ±0.05	X.X° ±0.5°					
UNIT	SIZE	SCALE	DRAWING NO.		SHEET	PROD. NAME
MM	A4	1:1	006-0082-001		1 OF 1	PART NO. XHB-2.54-XP-LT-DK
			TITLE			
			2.00 FPC CONN. ZIF SMT FRONTFLIP H=2.0 DOUBLE LOWER CONTACT			



SECTION A-A

SUGGESTED PCB LAYOUT
(COMPONENT SIDE)